

# GAP-247RL-S8

## 2U Rugged Server- Rear I/O & Rear Power supply Dual Socket 5<sup>th</sup>/4<sup>th</sup> Gen Intel® Xeon® Scalable Processors



**GAP** is a product family of rugged aluminum servers and workstations designed for applications that require robust and qualified MIL-GRADE equipment, suitable for operations in critical environments.

<b>2U</b> PLATFORM	<b>470 MM</b> DEPTH	<b>2</b> CPU	<b>4TB</b> RAM	<b>UP TO 9</b> HOT SWAP SSD	<b>6</b> I/O BOARDS
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GAP-247RL-S8 rugged servers are powered by dual-socket 5<sup>th</sup> Gen Intel® Xeon® / 4<sup>th</sup> Gen Intel® Xeon® Scalable processors known for their robust architecture with enhanced AI acceleration and advanced security capabilities. Offering improved performance and efficiency, they are tailored to meet the demanding requirements of modern computing environments, making them an ideal choice for mission-critical tasks and high-performance applications.

GAP-247RL-S8 are designed for 19" rackmounting and features a 2U chassis with a depth of 470mm. The rear I/O and rear power supply configuration offers versatile storage options, including two on board M.2 NVME SSD and either up to three removable 2.5" SAS SSD, six removable U.2 NVMe SSDs or up to nine removable 2.5" SATA SSDs. The GAP-247RL-S8 rugged servers can accommodate up to six low-profile PCIe cards.

For enhanced protection against shocks and vibrations, additional boards can be supplied with a dedicated retainer kit, ensuring optimal safety even during transport.

GAP servers are designed to meet MIL-STD-810F standards for temperature and shocks, as well as MIL-STD-167-1A standards for vibrations. Additionally, they can optionally conform to MIL-STD-461 standards for EMI/EMC. Upon request, MIL-GRADE connectors can be provided for the I/O connectors and power supply inputs.

All units are shipped with an inventory list to guarantee configuration control and reproducibility over time. Additionally, upon request, all server configurations can undergo specific thermal or mechanical environmental stress tests.

# Technical Specifications



## System

<b>CPU</b>	5 <sup>th</sup> Gen Intel® Xeon® / 4 <sup>th</sup> Gen Intel® Xeon® Scalable processors, Dual Socket LGA-4677 (Socket E) supported, CPU TDP Up to 270W TDP
<b>Memory</b>	Up to 4TB ECC RDIMM, DDR5-4800MHz, 16 DIMM slots
<b>Chipset</b>	Intel® C741
<b>Graphics</b>	1 Aspeed AST2600 BMC port
<b>Network Connectivity</b>	1x Dedicated IPMI LAN port 2x 10GbE with RJ45 connectors
<b>Storage</b>	Internal: 2x M.2 NVMe PCIe 4.0 x2; M-Key, 2280/22110 2x SATA Disk on Module (RAID 0,1)  Removable: Up to 3x 2.5" SAS SSD or Up to 6x U.2 NVMe SSD or Up to 9x 2.5" SATA SSD
<b>TPM</b>	1x TPM Header
<b>Motherboard I/O shield</b>	2x 10 GbE LAN, 1x BMC LAN, 4x USB 3.0, VGA; COM (available on the rear panel)
<b>Expansion slots</b>	2x PCIe 5.0 x8, 4x PCIe 5.0 x16
<b>Operative Systems</b>	Windows® 11 IoT Enterprise, Windows® 10 IoT Enterprise LTSC, Windows® Server 2022, Windows® Server 2019, Linux
<b>IPMI</b>	IPMI2.0, SPM, Watchdog; SNMP and e-mail alarms and notifications
<b>Remote Monitoring</b>	Monitoring, control, and management functions (fan speed, temperature, voltage, redundant power failure, power consumption, disk health, RAID health, and memory health)
<b>Power Supply</b>	
<b>Power Supply</b>	AC or DC Redundant Power Supply - Optional AC Single

## Mechanical

<b>Dimensions</b>	483 x 88 x 470 mm (W x H x D)
<b>Material</b>	Aluminum with surface passivation treatment
<b>Colour</b>	Black / RAL 9005 - Powder Coating
<b>Mounting</b>	2U 19" rackmount chassis Optional Telescopic slides
<b>Configuration</b>	Rear I/O - Rear Power Supply
<b>Front Panel Leds / Buttons / Connectors</b>	Power On/Off button with LED Reset button with LED 2x USB 3.0
<b>Fans</b>	6x internal PWM fans

## Environmental - (Design to meet)

<b>Operating Temperatures</b>	0°C to +50°C MIL-STD-810H, Method 501.7 & 502.7 -20°C to +60°C (depending on configuration)
<b>Storage Temperature</b>	-40°C to +70°C MIL-STD-810H, Method 501.7 & 502.7
<b>Humidity</b>	5% – 95% non-condensing MIL-STD-810H 507.6
<b>Operating Vibrations</b>	MIL-STD-167-1A, Type I
<b>Not Operating Vibrations</b>	1.17 Grms, 5-500 Hz MIL-STD-810H, Method 514.8
<b>Operating Shocks</b>	20g / 11ms – half sine MIL-STD-810G, Method 516.7
<b>EMC</b>	Directive 2014/35/UE-LVD   Directive 2014/30/UE-EMC   Directive 2011/65/UE - RoHS Regulation EC No 1907/2006   MIL-STD-461G (on request)

GAP servers and workstations are designed in accordance with the environmental specifications indicated. Some parameters depend on the configuration. Equipment may be subjected to dedicated test profiles.